2SJ601-Z-E1-AZ

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)		
- 60	0.020 at $V_{GS}$ = - 10 V	- 50		
- 00	0.025 at V <sub>GS</sub> = - 4.5 V	- 45		

### **FEATURES**

P-Channel 60 V (D-S) MOSFET

- TrenchFET<sup>®</sup> Power MOSFET
- Material categorization:

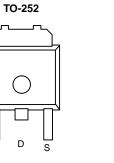


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## **APPLICATIONS**

· Load Switch



#### Top View

D G

# s GO

P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_A = 25 \text{ °C}$ , unless otherwise noted)						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V <sub>DS</sub>	- 60	v			
Gate-Source Voltage	V <sub>GS</sub>	± 20	V			
Continuous Drain Current ( $T_1 = 175 ^{\circ}C$ )	T <sub>C</sub> = 25 °C	I <sub>D</sub>	- 50			
Continuous Drain Current (1) = 175 C)	T <sub>C</sub> = 125 °C	סי	- 40	^		
Pulsed Drain Current	I <sub>DM</sub>	- 160	A			
Avalanche Current		I <sub>AS</sub>	- 50			
Single Pulse Avalanche Energy <sup>a</sup>	L = 0.1 mH	E <sub>AS</sub>	125	mJ		
Power Discinction	T <sub>C</sub> = 25 °C	Pn	113 <sup>c</sup>	w		
Power Dissipation	T <sub>A</sub> = 25 °C	'D	2.5 <sup>b, c</sup>			
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Junction-to-Ambient <sup>b</sup>	t ≤ 10 s	R <sub>thJA</sub>	15	18	°C/W	
Junction-to-Ambient"	Steady State		40	50		
Junction-to-Case		R <sub>thJC</sub>	0.82	1.1		

Notes:

a. Duty cycle  $\leq$  1 %.

b. When mounted on 1" square PCB (FR-4 material).

c. See SOA curve for voltage derating.

d. Package limited.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = -250 \mu A$	- 60			V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.5		- 3	v	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = - 60 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C			- 50	μA	
		V <sub>DS</sub> = - 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C			- 100		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = - 5 V, V <sub>GS</sub> = - 10 V	- 50			Α	
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 17 A		0.020			
	P	$V_{GS}$ = - 10 V, I <sub>D</sub> = - 40 A, T <sub>J</sub> = 125 °C		0.030		Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 40 A, T <sub>J</sub> = 150 °C		0.035			
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 14 A		0.025			
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 17 A		61		S	
Dynamic <sup>b</sup>	•	•					
Input Capacitance	C <sub>iss</sub>			2950			
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$ , $V_{DS} = -25 V$ , f = 1 MHz		380		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			305			
Total Gate Charge <sup>c</sup>	Qg			110	165		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -40 \text{ A}$		19		nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			28			
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			15	23		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = - 30 V, $R_L$ = 0.6 $\Omega$		70	105		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong$ - 40 A, $V_{GEN}$ = - 10 V, $R_G$ = 6		175	260	ns	
Fall Time <sup>c</sup>	t <sub>f</sub>	Ω		175	260		
Source-Drain Diode Ratings and Cha	aracteristics	$\Gamma_{\rm C} = 25 \ ^{\circ}{\rm C}^{\rm b}$					
Continuous Current	۱ <sub>S</sub>				- 40	^	
Pulsed Current	I <sub>SM</sub>				- 80	A	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = - 40 A, V <sub>GS</sub> = 0 V	40 A, V <sub>GS</sub> = 0 V - 1 - 1.6		- 1.6	V	
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = - 40 A, dl/dt = 100 A/µs 45 70		70	ns		

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %. b. Guaranteed by design, not subject to production testing.

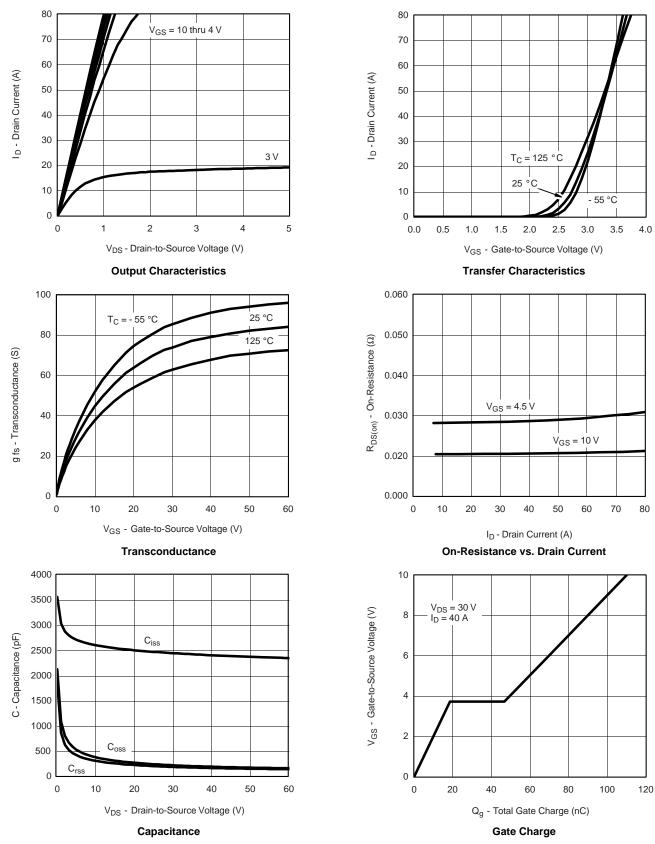
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

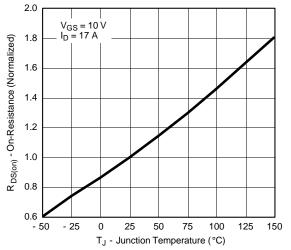
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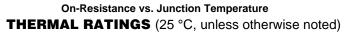


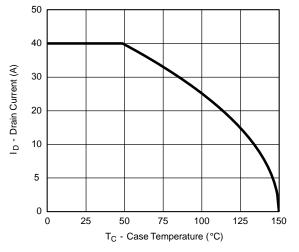




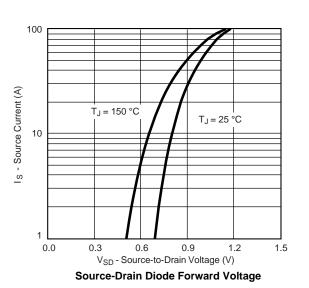


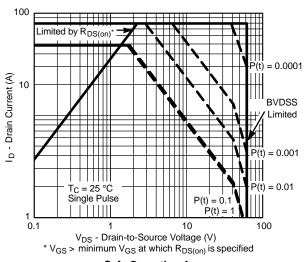
## TYPICAL CHARACTERISTICS

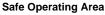


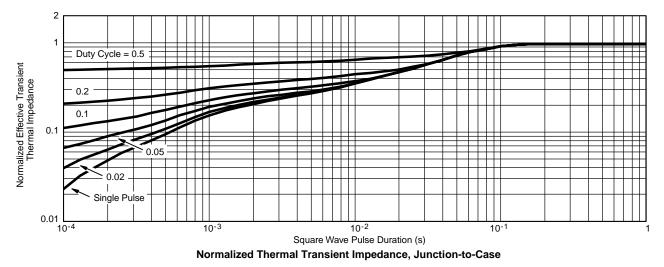


Drain Current vs. Case Temperature



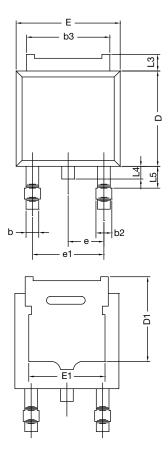








## **TO-252AA CASE OUTLINE**





	MILLIN	IETERS	INC	CHES		
DIM.	MIN.	MAX.	MIN.	MAX.		
А	2.18	2.38	0.086	0.094		
A1	-	0.127	-	0.005		
b	0.64	0.88	0.025	0.035		
b2	0.76	1.14	0.030	0.045		
b3	4.95	5.46	0.195	0.215		
С	0.46	0.61	0.018	0.024		
C2	0.46	0.89	0.018	0.035		
D	5.97	6.22	0.235	0.245		
D1	5.21	-	0.205	-		
E	6.35	6.73	0.250	0.265		
E1	4.32	-	0.170	-		
Н	9.40	10.41	0.370	0.410		
е	2.28	BSC	0.090 BSC			
e1	4.56	BSC	0.180 BSC			
L	1.40	1.78	0.055	0.070		
L3	0.89	1.27	0.035	0.050		
L4	-	1.02	-	0.040		
L5	1.14	1.52	0.045	0.060		
ECN: X12-0247-Rev. M, 24-Dec-12 DWG: 5347						

#### Note

• Dimension L3 is for reference only.



## **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)



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